

## Call for Nominations: Avram Bar-Cohen Memorial Medal – 2025

The Avram Bar-Cohen Memorial Medal is to honour a distinguished member of the electronic packaging community, Prof. Avram Bar-Cohen. In keeping with tradition, the award will continue to be given to a single individual at each InterPACK Conference. The same format will continue for this year's award with the winner to be announced prior to the [InterPACK 2025](#) Conference, to be held in Anaheim, CA, USA, October 28-30, 2025.



*Prof. Avram Bar-Cohen*

Nominations are solicited for the 2025 Avram Bar-Cohen Memorial Medal. Candidates must have demonstrated excellence over years and international recognition in the areas of research and development related to electronic packaging. They must also have a high level of service accomplishments to the technical community at large. Scientific and technical leadership is demonstrated by multiple means, including but not limited to publications, patents, technology and product development, and academic advising.

The nomination package should include:

1. [ASME Achievement Award Nomination Form](#).
2. A nomination letter with justification of the candidacy; no more than two pages.
3. Up to three additional letters of support. A minimum of two letters is required.
4. Detailed curriculum vitae of the nominee.

Please send the nomination package through the relevant [ASME Awards website](#), by 11:59 PM US Pacific Time, **February 15, 2025**.

Past nominees but non-winners will be grandfathered for two years beyond the original year of nomination. Any nominee that has gone through three cycles of the Award process will have to wait out one year before renomination. Incomplete nominations, or those submitted after the deadline will not be considered.

### Past winners include:

- 2022 Prof. Pradeep Lall, Auburn University
- 2023 Dr. Sreekant Narumanchi, National Renewable Energy Laboratory
- 2024 Dr. John Lau, Unimicron Technology Corporation